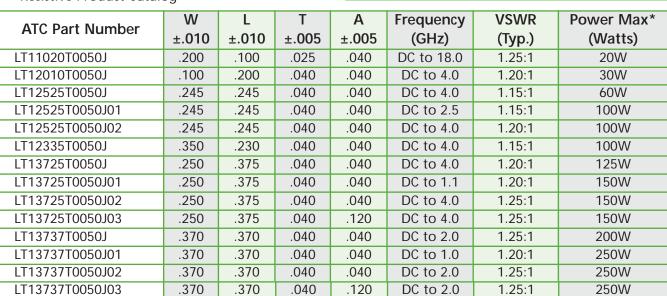
Leaded Chip Terminations

Style LT

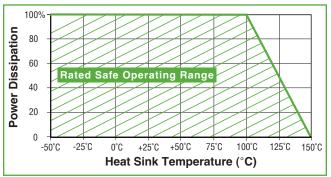
General Specifications

- Nominal Impedence: 50 Ω
- Resistive Tolerance: ±5% standard, ±2% available
- Operating Temp Range: -55 to +150°C
- Temperature Coefficient: ±150 ppm/°C
- Resistive Elements: Tantalum, Thin Film Processed
- Substrate Material: Aluminum Nitride
- Terminals: Silver over Nickel
- Lead-Free, RoHS Compliant
- Reliability: MIL-PRF-55342
- Tape and Reel Specifications: See Page 37 of Full **Resistive Product Catalog**

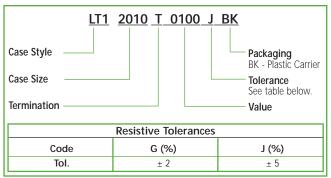


* Test Condition: Chip soldered to a large copper carrier whose surface is at 100°C; maximum rated power applied. Specification: The resistance of the film shall change no more than <2% during and after a 1000-hr. Burn-in per MIL-PRF-55342.

Power Derating



ATC Part Number Code



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